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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









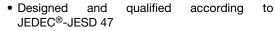
## Thyristor High Voltage, Phase Control SCR, 10 A



3L TO-220AB

PRIMARY CHARACTERISTICS							
I <sub>T(AV)</sub>	6.5 A						
V <sub>DRM</sub> /V <sub>RRM</sub>	800 V						
V <sub>TM</sub>	1.15 V						
I <sub>GT</sub>	15 mA						
T <sub>J</sub>	-40 °C to 125 °C						
Package	3L TO-220AB						
Circuit configuration	Single SCR						

#### **FEATURES**





- 125 °C max. operating junction temperature
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

 Typical usage is in input rectification crowbar (soft star) and AC switch in motor control, UPS, welding, and battery charge

#### **DESCRIPTION**

The VS-10TTS08... high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS									
APPLICATIONS	SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS								
Capacitive input filter  T <sub>A</sub> = 55 °C, T <sub>J</sub> = 125 °C,  common heatsink of 1 °C/W	13.5	17	А						

MAJOR RATINGS AND CHARACTERISTICS								
PARAMETER	TEST CONDITIONS	VALUES	UNITS					
I <sub>T(AV)</sub>	Sinusoidal waveform	6.5	٨					
I <sub>T(RMS)</sub>		10	Α					
V <sub>RRM</sub> /V <sub>DRM</sub>		800	V					
I <sub>TSM</sub>		110	A					
V <sub>T</sub>	6.5 A, T <sub>J</sub> = 25 °C	1.15	V					
dV/dt		150	V/µs					
dl/dt		100	A/µs					
T <sub>J</sub>	Range	-40 to +125	°C					

<b>VOLTAGE RATINGS</b>			
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>DRM</sub> , MAXIMUM PEAK DIRECT VOLTAGE V	I <sub>RRM</sub> /I <sub>DRM</sub> AT 125 °C mA
VS-10TTS08-M3	800	800	1.0



ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS			
Maximum average on-state current	I <sub>T(AV)</sub>	T 110 °C 100° condu	6.5					
Maximum RMS on-state current	I <sub>T(RMS)</sub>	T <sub>C</sub> = 112 °C, 180° conduc	Stion riaii Sirie wave	10	A			
Maximum peak, one-cycle,	l	10 ms sine pulse, rated V	<sub>RRM</sub> applied, T <sub>J</sub> = 125 °C	95	^			
non-repetitive surge current	I <sub>TSM</sub>	10 ms sine pulse, no volta	10 ms sine pulse, no voltage reapplied, $T_J = 125$ °C					
Maximum I <sup>2</sup> t for fusing	l <sup>2</sup> t	10 ms sine pulse, rated V	<sub>RRM</sub> applied, T <sub>J</sub> = 125 °C	45	A <sup>2</sup> s			
Maximum i-t for fusing	1-1	10 ms sine pulse, no volta	age reapplied, T <sub>J</sub> = 125 °C	64	A <sup>z</sup> S			
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 ms to 10 ms, no vo	640	A²√s				
Maximum on-state voltage drop	V <sub>TM</sub>	6.5 A, T <sub>J</sub> = 25 °C	6.5 A, T <sub>J</sub> = 25 °C					
On-state slope resistance	r <sub>t</sub>	T 405.00		17.3	mΩ			
Threshold voltage	V <sub>T(TO)</sub>	- T <sub>J</sub> = 125 °C		0.85	V			
Maximum reverse and direct leakage	1 /1	T <sub>J</sub> = 25 °C	V Detect V A/	0.05				
current	I <sub>RM</sub> /I <sub>DM</sub>	T <sub>J</sub> = 125 °C	$V_R = Rated V_{RRM}/V_{DRM}$	1.0				
Typical holding current	I <sub>H</sub>	Anode supply = 6 V, res $T_J = 25  ^{\circ}C$	30	mA				
Maximum latching current	ال	Anode supply = 6 V, res	50					
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max., linear to } 80$	$0\%$ , $V_{DRM} = R_g - k = Open$	150	V/µs			
Maximum rate of rise of turned-on current	dl/dt			100	A/µs			

TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum peak gate power	$P_{GM}$		8.0	W	
Maximum average gate power	P <sub>G(AV)</sub>		2.0	VV	
Maximum peak positive gate current	+l <sub>GM</sub>		1.5	Α	
Maximum peak negative gate voltage	-V <sub>GM</sub>		10	V	
	I <sub>GT</sub>	Anode supply = 6 V, resistive load, T <sub>J</sub> = - 65 °C	20	mA	
Maximum required DC gate current to trigger		Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C	15		
		Anode supply = 6 V, resistive load, T <sub>J</sub> = 125 °C	10		
		Anode supply = 6 V, resistive load, T <sub>J</sub> = - 65 °C	1.2		
Maximum required DC gate voltage to trigger	$V_{GT}$	Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C	1	v	
voltage to trigger		Anode supply = 6 V, resistive load, T <sub>J</sub> = 125 °C	0.7	V	
Maximum DC gate voltage not to trigger	$V_{GD}$	T. = 105 °C V Poted value	0.2	1	
Maximum DC gate current not to trigger	I <sub>GD</sub>	T <sub>J</sub> = 125 °C, V <sub>DRM</sub> = Rated value	0.1	mA	

SWITCHING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Typical turn-on time	t <sub>gt</sub>	T <sub>J</sub> = 25 °C	0.8					
Typical reverse recovery time	t <sub>rr</sub>	T 105 °C	3	μs				
Typical turn-off time	tq	T <sub>J</sub> = 125 °C	100					



THERMAL AND MECHANICAL SPECIFICATIONS								
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum junction and storage temperature range		T <sub>J</sub> , T <sub>Stg</sub>		-40 to +125	°C			
Maximum thermal resistance, junction to case		R <sub>thJC</sub>	DC operation	1.5				
Maximum thermal resistance, junction to ambient		R <sub>thJA</sub>		62	°C/W			
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	Mounting surface, smooth and greased	0.5				
Annyayimata wajaht				2	g			
Approximate weight				0.07	OZ.			
Mounting torque	minimum			6 (5)	kgf · cm			
Mounting torque -	maximum			12 (10)	(lbf ⋅ in)			
Marking device			Case style 3L TO-220AB	10TTS08				

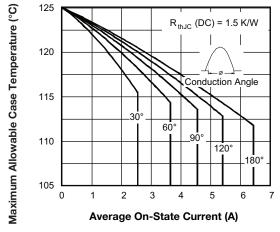


Fig. 1 - Current Rating Characteristics

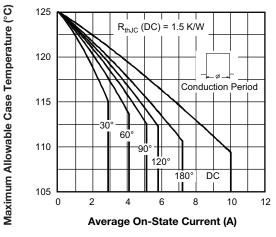


Fig. 2 - Current Rating Characteristic

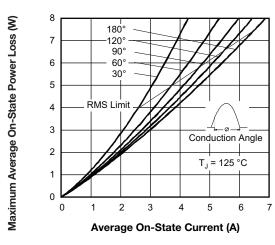


Fig. 3 - On-State Power Loss Characteristics

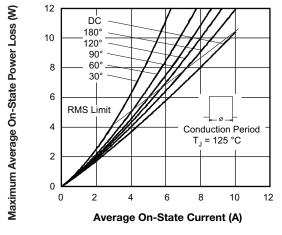
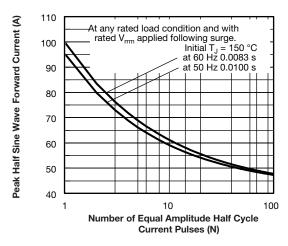


Fig. 4 - On-State Power Loss Characteristics





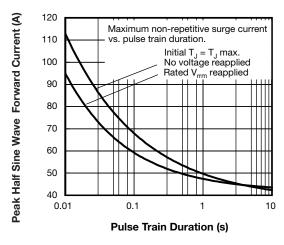


Fig. 6 - Maximum Non-Repetitive Surge Current

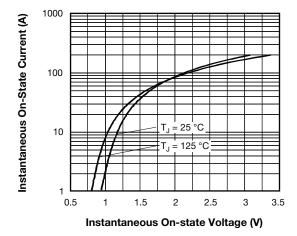


Fig. 7 - On-State Voltage Drop Characteristics

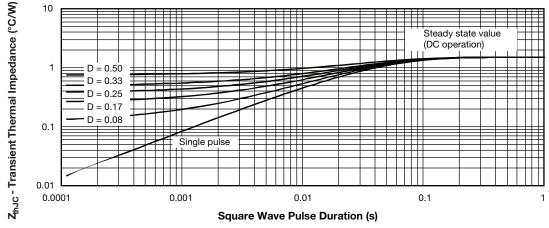
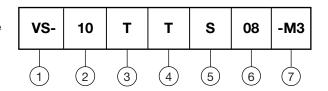


Fig. 8 - Thermal Impedance ZthJC Characteristics



#### **ORDERING INFORMATION TABLE**

#### Device code



1 - Vishay Semiconductors product

2 - Current rating

Circuit configuration:

T = single thyristor

4 - Package:

T = TO-220AB

5 - Type of silicon:

S = converter grade

6 - Voltage code x 100 = V<sub>RRM</sub>

7 - Environmental digit:

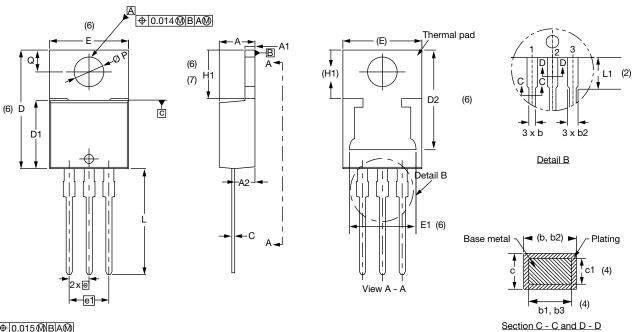
-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)								
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION								
VS-10TTS08-M3	50	1000	Antistatic plastic tubes					

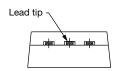
LINKS TO RELATED DOCUMENTS						
Dimensions www.vishay.com/doc?96154						
Part marking information	www.vishay.com/doc?95028					

### **3L TO-220AB**

#### **DIMENSIONS** in millimeters and inches



Ф 0.015 M B A M



Conforms to JEDEC® outline TO-220AB

SYMBOL	MILLIM	MILLIMETERS		INCHES NOTES		NOTES		MILLIN	IETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES		SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183			D2	11.68	12.88	0.460	0.507	6
A1	1.14	1.40	0.045	0.055			E	10.11	10.51	0.398	0.414	3, 6
A2	2.50	2.92	0.098	0.115			E1	6.86	8.89	0.270	0.350	6
b	0.69	1.01	0.027	0.040			е	2.41	2.67	0.095	0.105	
b1	0.38	0.97	0.015	0.038	4		e1	4.88	5.28	0.192	0.208	
b2	1.20	1.73	0.047	0.068			H1	6.09	6.48	0.240	0.255	6, 7
b3	1.14	1.73	0.045	0.068	4		L	13.52	14.02	0.532	0.552	
С	0.36	0.61	0.014	0.024			L1	3.32	3.82	0.131	0.150	2
c1	0.36	0.56	0.014	0.022	4		ØΡ	3.54	3.91	0.139	0.154	
D	14.85	15.35	0.585	0.604	3		Q	2.60	3.00	0.102	0.118	
D1	8.38	9.02	0.330	0.355								·

#### Notes

- <sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3, and c1 apply to base metal only
- Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- (7) Outline conforms to JEDEC® TO-220, except D2 (minimum)



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